

SIPMOS[®] Small-Signal-Transistor

Feature

- N-Channel
- · Enhancement mode
- Logic level
- dv/dt rated
- Pb-free lead-plating; RoHS compliant
- Qualified according to AEC Q101
- Halogen-free according to IEC61249-2-21



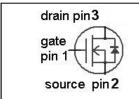




Product Summary

$V_{ m DS}$	240	V
$R_{\mathrm{DS(on),max}}$	14	Ω
I _D	0.1	Α

PG-SOT-23





Туре	Package	Pb-free	Tape and Reel Information	Marking
BSS131	PG-SOT23	Yes	H6327	SRs

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	ID	T _A =25 °C	0.11	А
		T _A =70 °C	0.09	
Pulsed drain current	I _{D,pulse}	T _A =25 °C	0.4	
Reverse diode dv/dt	dv/dt	$I_{\rm D}$ =0.1 A, $V_{\rm DS}$ =192 V, d <i>i</i> /d <i>t</i> =200 A/ μ s, $T_{\rm j,max}$ =150 °C	6	kV/μs
Gate source voltage	V_{GS}		±20	V
ESD Class		JESD22-A114-HBM	Class 0	
Power dissipation	P_{tot}	T _A =25 °C	0.36	W
Operating and storage temperature	$T_{\rm j},T_{\rm stg}$		-55 150	°C
IEC climatic category; DIN IEC 68-1			55/150/56	



Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal characteristics						
Thermal resistance, junction - minimal footprint	R_{thJA}		-	-	350	K/W

Electrical characteristics, at $T_{\rm j}$ =25 °C, unless otherwise specified

Static characteristics

Drain-source breakdown voltage	$V_{(BR)DSS}$	V _{GS} =0 V, I _D =250 μA	240	-	1	V
Gate threshold voltage	$V_{\rm GS(th)}$	$V_{\rm DS}$ =0 V, $I_{\rm D}$ =56 μA	0.8	1.4	1.8	
Drain-source leakage current	I _{D (off)}	V _{DS} =240 V, V _{GS} =0 V, T _j =25 °C	ı	ı	0.01	μΑ
		V _{DS} =240 V, V _{GS} =0 V, T _j =150 °C	1	1	5	
Gate-source leakage current	I _{GSS}	V _{GS} =20 V, V _{DS} =0 V	1	1	10	nA
Drain-source on-state resistance	$R_{\mathrm{DS(on)}}$	V _{GS} =4.5 V, I _D =0.09 A	1	9.07	20	Ω
		V _{GS} =10 V, I _D =0.1 A	1	7.7	14	
Transconductance	g_{fs}	$ V_{\rm DS} > 2 I_{\rm D} R_{\rm DS(on)max},$ $I_{\rm D} = 0.08 \text{ A}$	0.06	0.13	-	S



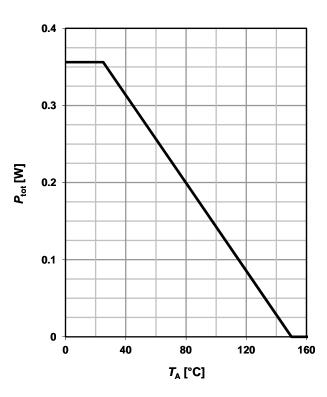
Parameter	Symbol	Symbol Conditions	Values			Unit
			min.	typ.	max.	
Dynamic characteristics						
Input capacitance	Ciss		-	58	77	pF
Output capacitance	Coss	V _{GS} =0 V, V _{DS} =25 V, f=1 MHz	-	7.3	10	
Reverse transfer capacitance	C _{rss}		-	2.8	4.2	
Turn-on delay time	t _{d(on)}		-	3.3	5.0	ns
Rise time	t _r	V _{DD} =120 V, V _{GS} =10 V, I _D =0.1 A,	-	3.1	4.6	
Turn-off delay time	$t_{d(off)}$	$R_{\rm G}$ =6 Ω	-	13.7	20	
Fall time	t _f]	-	64.5	97	
Gate Charge Characteristics				r		
Gate to source charge	Q _{gs}]	-	0.16	0.22	nC
Gate to drain charge	Q _{gd}	V _{DD} =192 V, I _D =0.1 A,	-	8.0	1.2	
Gate charge total	Q_g	V _{GS} =0 to 10 V	-	2.1	3.1	
Gate plateau voltage	V_{plateau}		-	2.90	-	V
Reverse Diode						
Diode continous forward current	Is	T -25 °C	-	-	0.11	А
Diode pulse current	I _{S,pulse}	T _A =25 °C	-	-	0.43]
Diode forward voltage	V _{SD}	V _{GS} =0 V, I _F =0.1 A, T _j =25 °C	-	0.81	1.2	V
Reverse recovery time	t _{rr}	V _R =120 V, I _F =0.1 A,	-	42.9	64.3	ns
Reverse recovery charge	Q _{rr}	$di_F/dt=100 \text{ A/µs}$	_	22.6	34	nC

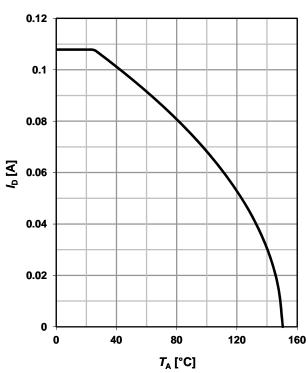


1 Power dissipation

$P_{\text{tot}} = f(T_A)$

2 Drain current





3 Safe operating area

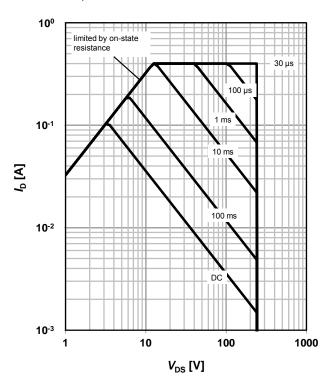
 I_D =f(V_{DS}); T_A =25 °C; D=0

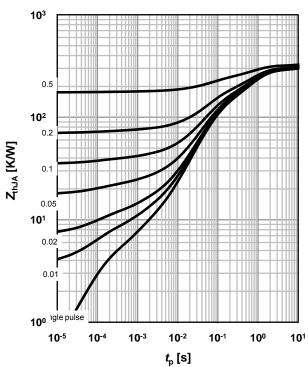
parameter: t_p

4 Max. transient thermal impedance

 Z_{thJA} =f(t_{p})

parameter: $D=t_p/T$



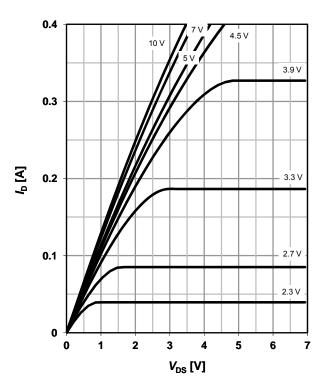




5 Typ. output characteristics

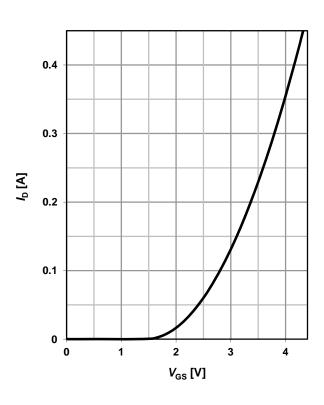
 $I_D = f(V_{DS}); T_j = 25 °C$

parameter: $V_{\rm GS}$



7 Typ. transfer characteristics

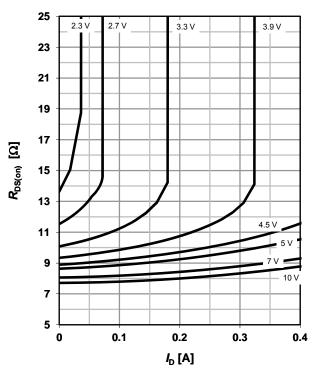
 I_{D} =f(V_{GS}); $|V_{DS}|$ >2 $|I_{D}|R_{DS(on)max}$



6 Typ. drain-source on resistance

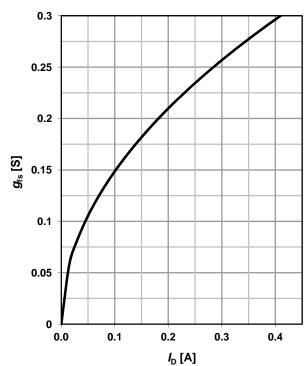
 $R_{DS(on)}=f(I_D); T_j=25 °C$

parameter: V_{GS}



8 Typ. forward transconductance

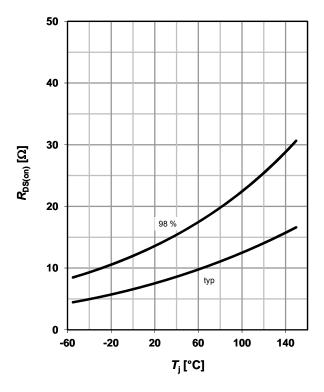
 g_{fs} =f(I_D); T_j =25 °C





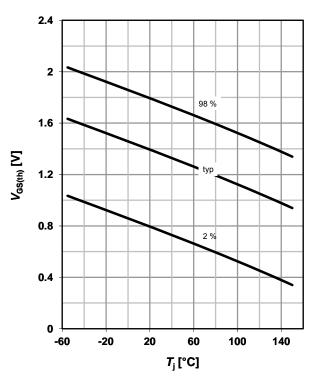
9 Drain-source on-state resistance

 $R_{DS(on)} = f(T_i); I_D = 0.1 A; V_{GS} = 10 V$



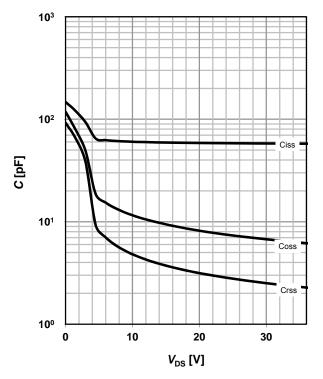
10 Typ. gate threshold voltage $V_{GS(th)}$ =f(T_j); V_{DS} = V_{GS} ; I_D =56 μ A

 $V_{GS(th)}=f(I_j); V_{DS}=V_{GS}; I_D=56 \mu A$ parameter: I_D



11 Typ. capacitances

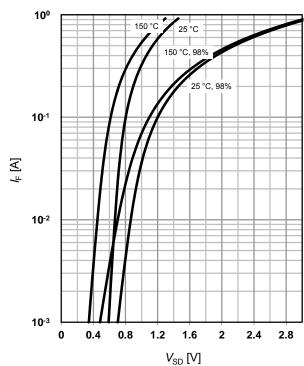
 $C=f(V_{DS}); V_{GS}=0 V; f=1 MHz; T_j=25$ °C



12 Forward characteristics of reverse diode

 $I_{\mathsf{F}} = \mathsf{f}(V_{\mathsf{SD}})$

parameter: T_i





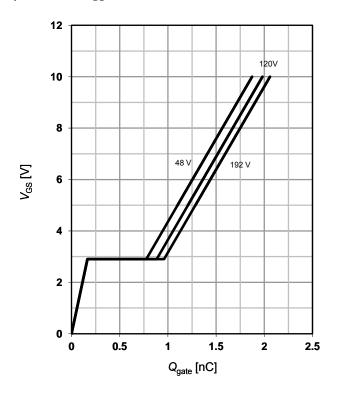
13 Typ. gate charge

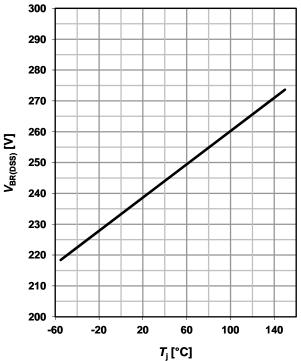
 $V_{\rm GS}$ =f(Q_{gate}); $I_{\rm D}$ =0.1 A pulsed

parameter: $V_{\rm DD}$

14 Drain-source breakdown voltage

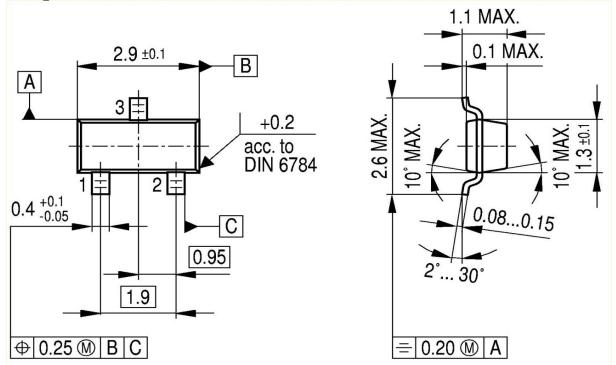
$$V_{BR(DSS)}$$
=f(T_j); I_D =250 μ A



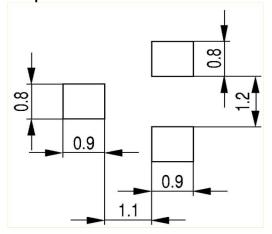




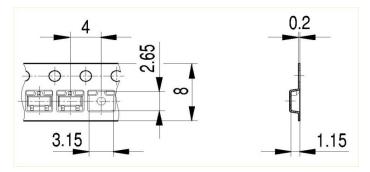
Package Outline:



Footprint:



Packaging:





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